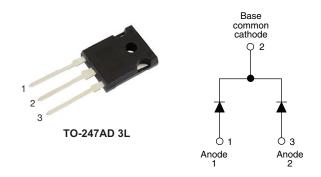


# Hyperfast Soft Recovery Diode, 2 x 15 A FRED Pt<sup>®</sup> Gen 4



PRIMARY CHARACTERISTICS						
I <sub>F(AV)</sub>	2 x 15 A					
$V_{R}$	600 V					
V <sub>F</sub> at I <sub>F</sub>	1.28 V					
t <sub>rr</sub> typ.	See Recovery table					
T <sub>J</sub> max.	175 °C					
Package	TO-247AD 3L					
Circuit configuration	Common cathode					

#### **FEATURES**

- Gen 4 FRED Pt® technology
- Low I<sub>RRM</sub> and reverse recovery charge
- · Very low forward voltage drop
- Polyimide passivated chip for high reliability standard



- 175 °C operating junction temperature
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### **DESCRIPTION**

Gen 4 Fred technology, state of the art, ultralow  $V_{\text{F}}$ , soft switching optimized for Discontinuous (Critical) Mode (DCM) and IGBT F/W diode.

The minimized conduction loss, optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Peak repetitive reverse voltage	$V_{RRM}$		600	V		
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 142 °C	15	۸		
Non-repetitive peak surge current, per leg	I <sub>FSM</sub>	$T_C = 25$ °C, $t_p = 8.3$ ms, half sine wave	200	A		
Operating junction and storage temperature	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C		

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	600	-	-		
		I <sub>F</sub> = 15 A	-	1.6	1.9		
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 30 A	-	1.87	-	V	
		I <sub>F</sub> = 15 A, T <sub>J</sub> = 125 °C	-	1.35	-		
		I <sub>F</sub> = 30 A, T <sub>J</sub> = 125 °C	-	1.67	-		
		I <sub>F</sub> = 15 A, T <sub>J</sub> = 150 °C	-	1.28	1.52		
		I <sub>F</sub> = 30 A, T <sub>J</sub> = 150 °C	-	1.61	-		
Developed to the control of the cont		V <sub>R</sub> = V <sub>R</sub> rated	-	-	15		
Reverse leakage current	I <sub>R</sub>	T <sub>J</sub> = 125 °C, V <sub>R</sub> = V <sub>R</sub> rated	-	-	500	μA	
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 600 V	-	16	-	pF	



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS				MAX.	UNITS	
Boyeros resovens timo		T <sub>J</sub> = 25 °C	I <sub>F</sub> = 15 A dI <sub>F</sub> /dt = 1000 A/μs V <sub>R</sub> = 400 V	-	50	-	ns	
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	70	-		
Dook roccycer courrent	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	8.5	-	Α	
Peak recovery current		T <sub>J</sub> = 125 °C		-	16	-	_ A	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	250	-	nC	
		T <sub>J</sub> = 125 °C		-	600	-	nC	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	1.4		
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	-	-	40	°C/W	
Thermal resistance, case to heat sink	R <sub>thCS</sub>		-	0.4	-		
Weight			-	6.0	-	g	
weignt			-	0.21	-	oz.	
Mounting torque			6.0 (5)	-	12 (10)	kgf · cm (lbf · in)	
Marking device		Case style TO-247AD 3L		C4PH3006L		•	

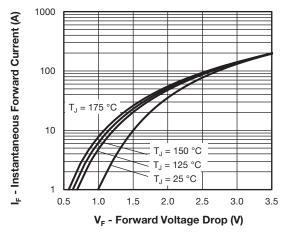


Fig. 1 - Typical Forward Voltage Drop Characteristics

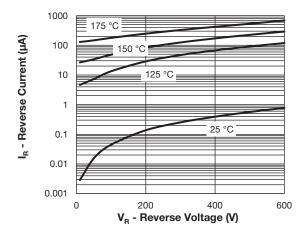


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

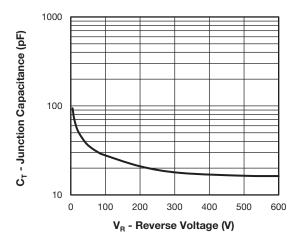


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

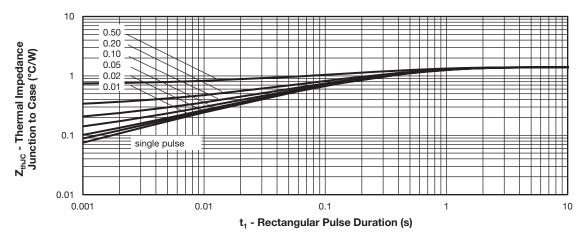


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

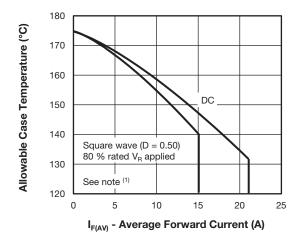


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

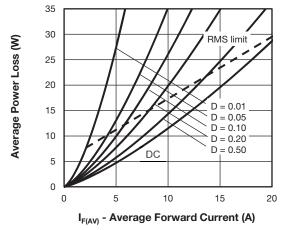


Fig. 6 - Forward Power Loss Characteristics

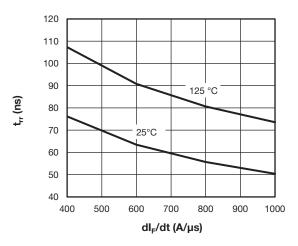
#### Note

<sup>(1)</sup> Formula used: T<sub>C</sub> = T<sub>J</sub> - (P<sub>d</sub> + P<sub>dREV</sub>) x R<sub>thJC</sub>; Pd = forward power loss = I<sub>F(AV)</sub> x V<sub>FM</sub> at (I<sub>F(AV)</sub>/D) (see Fig.5) P<sub>dREV</sub> = inverse power loss = V<sub>R1</sub> x I<sub>R</sub> (1 - D); I<sub>R</sub> at V<sub>R</sub> = rated V<sub>R</sub>



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# Vishay Semiconductors



700 600 125 °C 500 Q<sub>rr</sub> (nC) 400 300 25 °C 200 100 600 700 800 1000 400 500 900 dI<sub>F</sub>/dt (A/μs)

Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

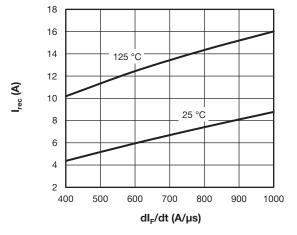
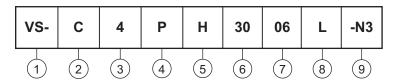


Fig. 9 - Typical Reverse Current vs. dl<sub>F</sub>/dt



#### **ORDERING INFORMATION TABLE**

Device code



1 - Vishay Semiconductors product

2 - Circuit configuration:

C = common cathode

3 - FRED Pt Gen 4

4 - P = TO-247 package

- Process type:

H = hyperfast recovery

6 - Current rating (30 = 2 x 15 A)

7 - Voltage rating (06 = 600 V)

8 - Package: L = long lead

9 - Environmental digit:

-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

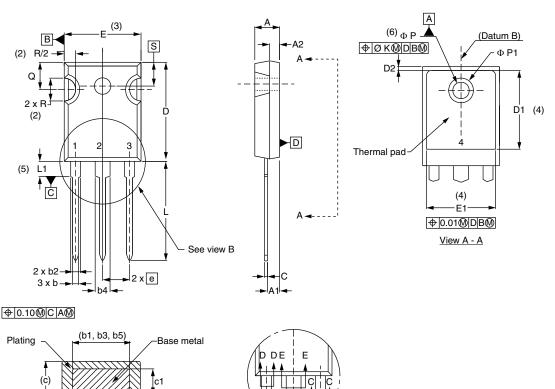
ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-C4PH3006L-N3	25	500	Antistatic plastic tube			

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95626			
Part marking information	www.vishay.com/doc?95007			



## **TO-247AD 3L**

#### **DIMENSIONS** in millimeters and inches



(e, be, be, be) (4) Section C - C, D - D, E - E							
SYMBOL	MILLIN	IETERS	INCHES		NOTES		
STIVIDUL	MIN.	MAX.	MIN.	MAX.	NOTES		
Α	4.65	5.31	0.183	0.209			
A1	2.21	2.59	0.087	0.102			
A2	1.50	2.49	0.059	0.098			
b	0.99	1.40	0.039	0.055			

0.039

0.065

0.065

0.102

0.102

0.015

0.015

0.776

0.515

0.053

0.094

0.092

0.135

0.133

0.035

0.033

0.815

(h h2 h4)

:5	

View B

SYMBOL	IVIILLIIV	MILLIMILIENS INCITES NOT			NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØΚ	0.254		0.0	10	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51	BSC	0.217	BSC	
•	•		•		•

INCHES

MILLIMETERS

#### Notes

b1

b2

b3

b4

b5

С

с1

D

D1

(1) Dimensioning and tolerancing per ASME Y14.5M-1994

1.35

2.39

2.34

3.43

3.38

0.89

0.84

20.70

- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body

3

- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1

0.99

1.65

1.65

2.59

2.59

0.38

0.38

19.71

13.08

- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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